

Datasheet of LTCC Device

Laminated Ceramic Antenna

2450 MHz

P/N: HXD BT-8

*Contents in this sheet are subject to change without prior notice.

LTCC Antenna 3216 Size

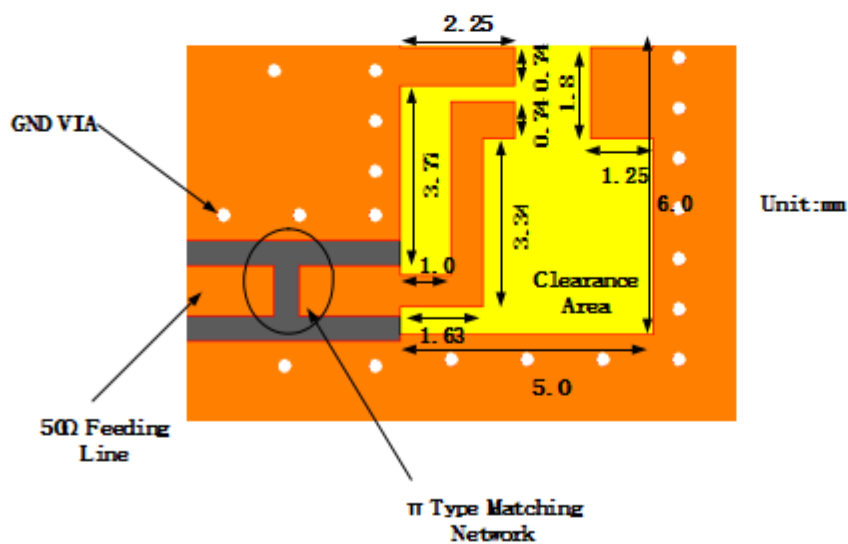
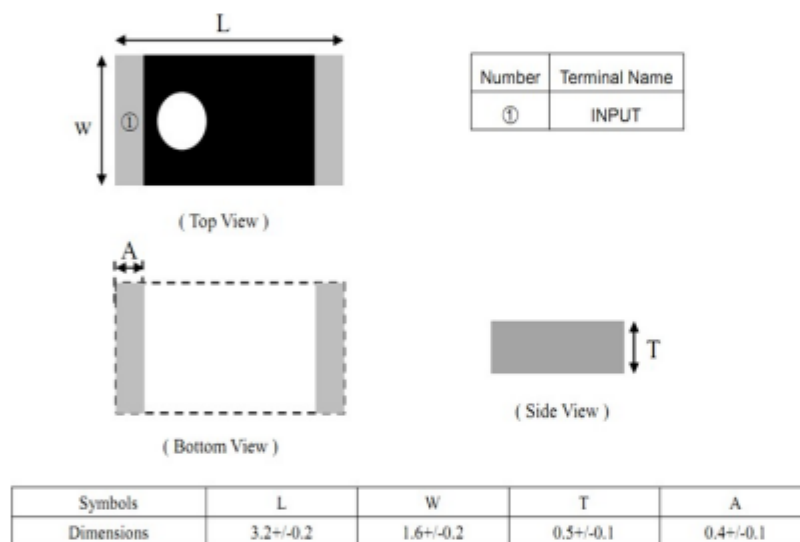
1. Features

Antenna Frequency for 2450 MHz

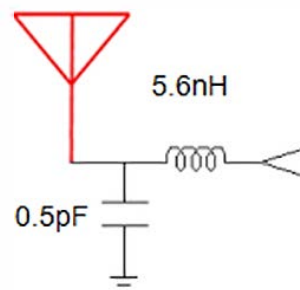
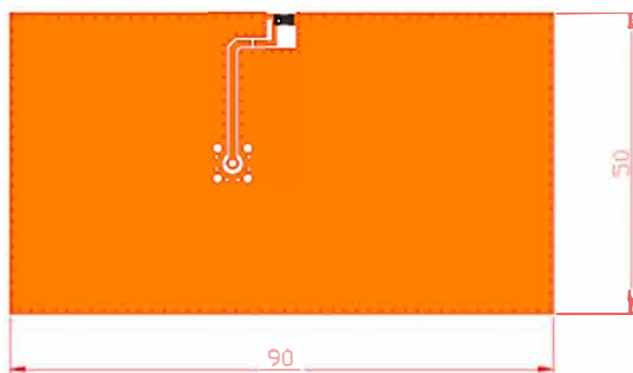
2. Applications

For Miniaturized Bluetooth System

3. Shapes & Dimensions (mm)



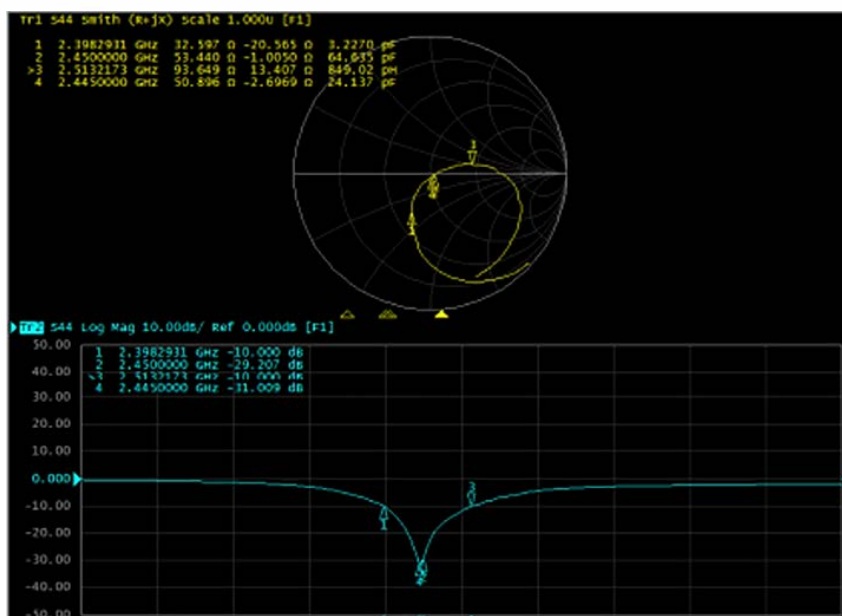
4. Evaluation Board and Matching Circuits



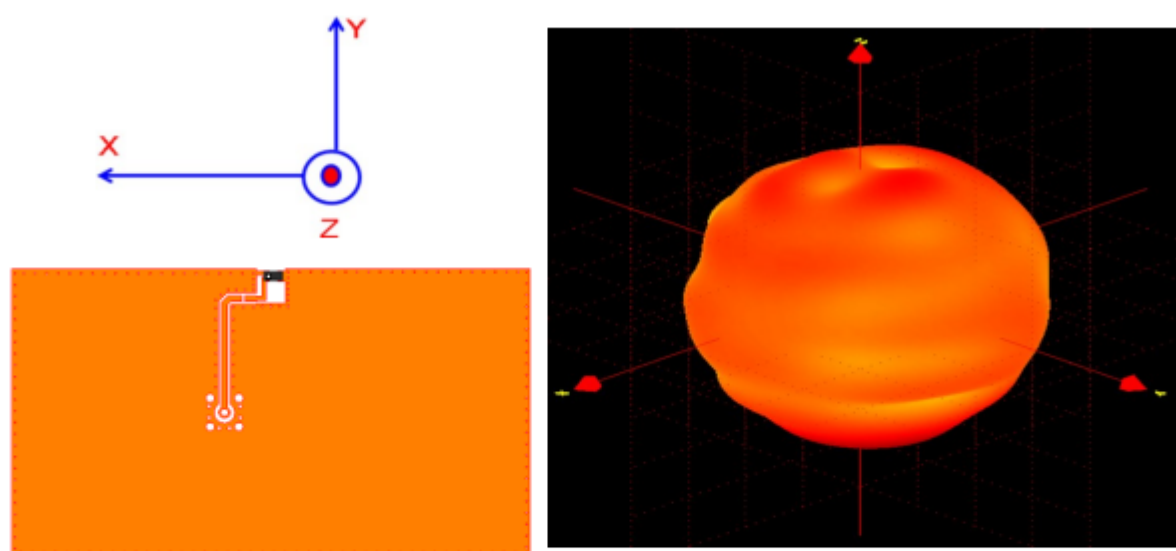
5. Electrical Characteristics

Item	Specifications
After Matching	2450MHz
Band Width	100 MHz typ.
Peak Gain	4.08 dBi
V.S.W.R	≤2.0
Polarization	Linear
Azimuth Beam width	Omni-directional
Impedance	50 Ω

6. Characteristic curve



7. Radiation Pattern & Efficiency

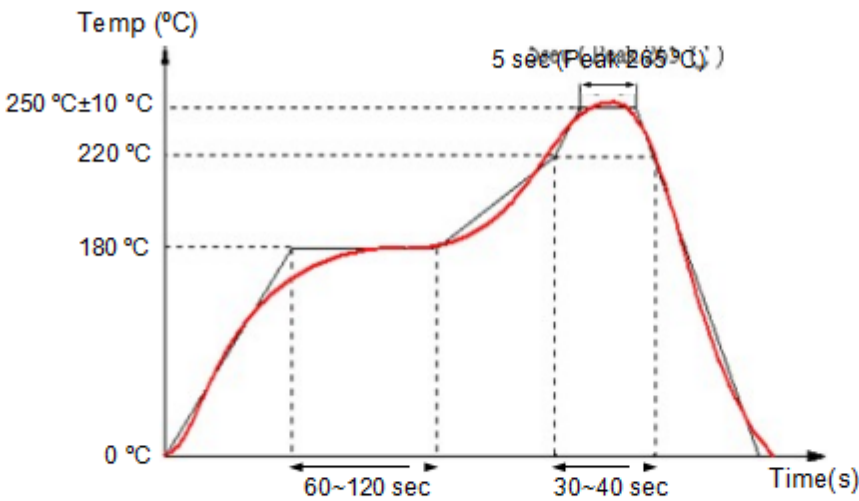


Frequency (MHz)	2400	2450	2500
Avg. Gain (dBi)	-1.91	-1.30	-1.48
Peck Gain (dBi)	1.76	4.08	2.53
Efficiency (%)	72.1	78.2	71.8

8. Post Dependability Tolerance

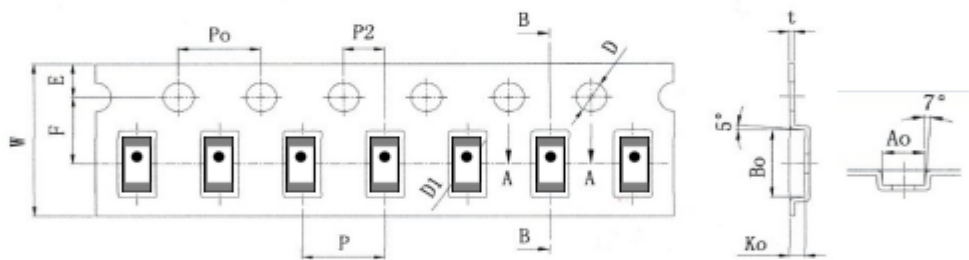
Item	Post Dependability Tolerance
Central Frequency	± 5 MHz
Band Width	± 5 MHz
Gain	± 0.1 dBi
V.S.W.R (in BW)	± 0.1

9. Reflow Soldering Standard Condition



10. Packaging and Dimensions 3216

◆ Plastic Tape

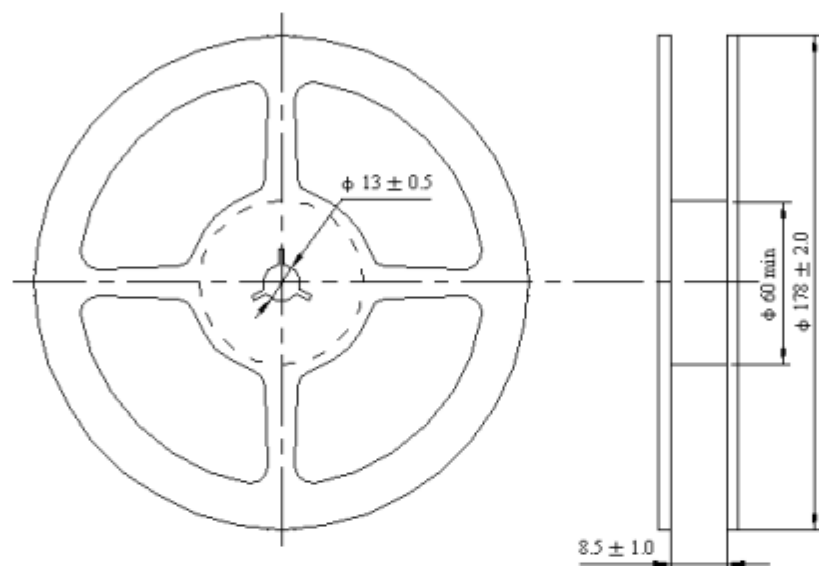


外觀	規格	公差
W	8.00	±0.10
P	4.00	±0.10
E	1.75	±0.10
F	3.50	±0.05
P2	2.00	±0.05
D	1.50	+0.10 -0.00
D1	1.00	±0.10
Po	4.00	±0.10
10Po	40.00	±0.20

外觀	規格	公差
Ao	1.85	±0.10
Bo	3.50	±0.10
Ko	0.73	±0.10
t	0.23	±0.05

◆ Remarks for Package

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

◆ Reel (6000 pcs/Reel)**◆ Storage Period**

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

11. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature: $240 \pm 5^{\circ}\text{C}$ *Immersion time: 2 ± 0.5 sec Solder: Sn96.5 Ag3.0 Cu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature: $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time: 10 ± 1 sec Solder : Sn96.5 Ag3.0 Cu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature: $120 \sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature: $260 \pm 5^{\circ}\text{C}$ *Immersion time: 10 ± 1 sec Solder: Sn 96.5 Ag 3.0 Cu0.5 for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer's specification.	*Height: 50 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency: 10Hz~55Hz~10Hz(1min) *Total amplitude: 1.5mm *Test times: 6hrs. (Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force: $5\text{N}(\leq 0603)$; $10\text{N}(>0603)$ *Test time: 10 ± 1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at -40°C±2°C. 10~15 minutes at room temperature. 30minutes at +85°C±2°C. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature: 85°C±2°C. *Test duration: 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity: 85±5%R.H. *Temperature: 85±2°C *Time: 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature: -40°C±2°C *Test duration: 500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.